
USB HIGH-SIDE POWER SWITCH

NO.EA-188-190627

OUTLINE

The R5524x is a CMOS-based high-side MOSFET switch IC which conforms to the universal serial bus (USB) standard. The device is suitable for protecting a USB power source. By using an Nch MOSFET with low On-resistance (Typ. 100 mΩ) as a switching transistor, the device can provide low dropout voltage. Internally, the device consists of an overcurrent limiting circuit, a thermal shutdown circuit, an undervoltage lockout (UVLO) circuit and a reverse current protection circuit. The device also consists of an internal delay circuit to prevent the output of false flag signals caused by inrush current. To achieve simplification of layout design, the overcurrent detection accuracy has been improved. The R5524x is offered in a 5-pin SOT-23-5 package and a 6-pin DFN(PLP)1820-6 package which achieve the smallest possible footprint solution on boards where area is limited.

FEATURES

- N-channel MOS High-Side Switch IC
- Switch ON Resistance Typ. 100 mΩ at 5 V Input
- Current Limit Threshold Min. 650 mA⁽¹⁾, Min. 1.25 A⁽²⁾
- Overcurrent Limit Min. 550 mA
- Flag Delay Time Typ. 20 ms
- Under-voltage Lockout (UVLO) Circuit
- Thermal Shutdown Circuit
- Reverse Current Protection Circuit
- Package SOT-23-5, DFN(PLP)1820-6⁽³⁾

APPLICATIONS

- PCs and PC Peripherals
- Digital Televisions (DTV)
- Set Top Boxes (STB)
- Printers
- PDA
- Game Consoles

⁽¹⁾ Only for R5524x001A/B, R5524x002A/B

⁽²⁾ Only for R5524N004A

⁽³⁾ Only for R5524K001x, R5524K002x

R5524x

NO.EA-188-190627

■ SELECTION GUIDE

The overcurrent limit protection type, the current limit threshold and the auto discharge options⁽¹⁾ for the ICs are user-selectable options.

Selection Guide

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R5524N00x*-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes
R5524K00x*-TR	DFN(PLP)1820-6	5,000 pcs	Yes	Yes

x: Specify the combination of Overcurrent Limit Protection type and Current Limit Threshold.

1: Latch-off Type, Current Limit Threshold: Min. 650 mA

2: Constant Current Type, Current Limit Threshold: Min. 650 mA

4: Constant Current Type, Current Limit Threshold: Min. 1.25 A⁽²⁾

*: Specify auto-discharge options.

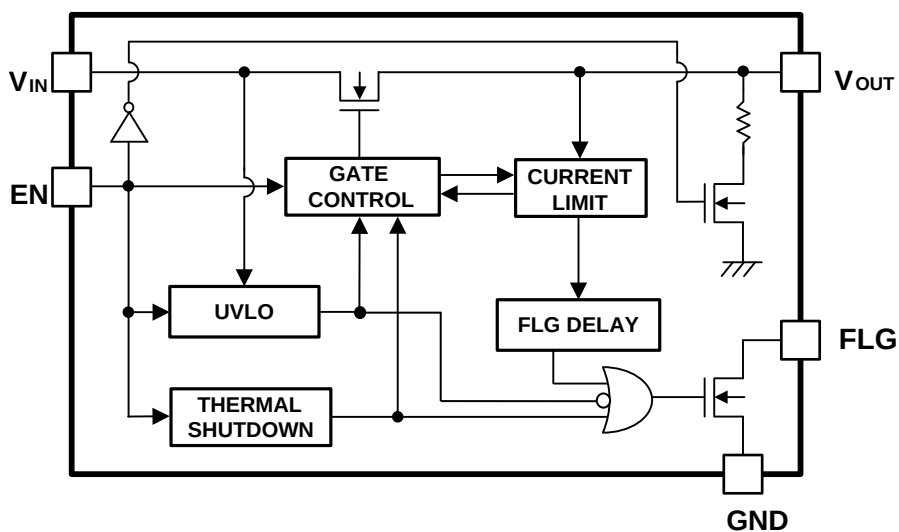
A: Auto-discharge included

B: Auto-discharge not included

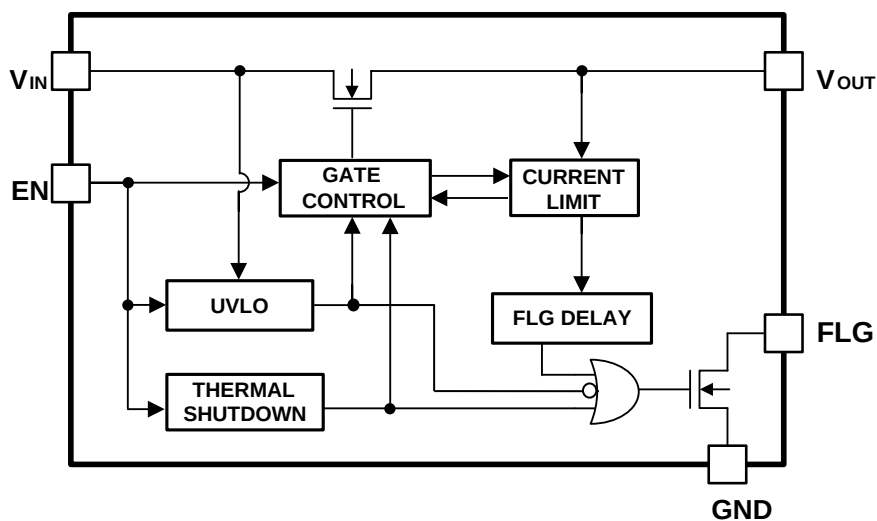
⁽¹⁾ Auto-discharge function quickly lowers the output voltage to 0 V, when the chip enable signal is switched from the active mode to the standby mode, by releasing the electrical charge accumulated in the external capacitor.

⁽²⁾ Only for R5524N004A

BLOCK DIAGRAMS



R5524xxxxA Block Diagram

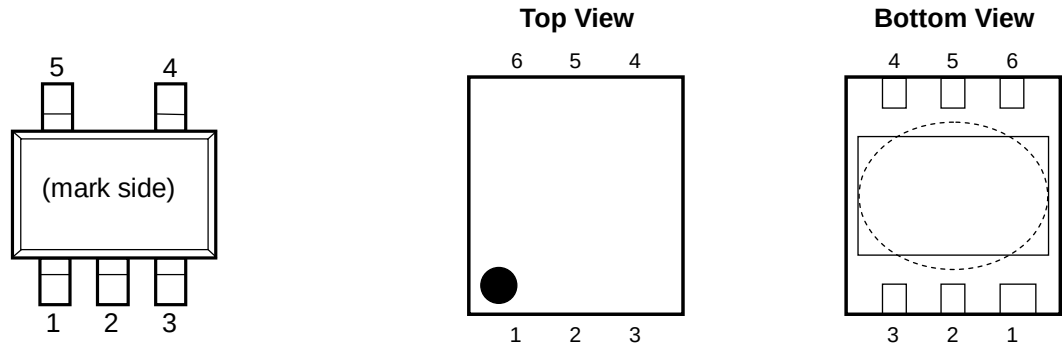


R5524xxxxB Block Diagram

R5524x

NO.EA-188-190627

PIN DESCRIPTIONS



R5524N (SOT-23-5) Pin Configuration

R5524K (DFN(PLP)1820-6) Pin Configuration

R5524N Pin Description

Pin No.	Symbol	Description
1	VIN	Input Pin
2	GND	Ground Pin
3	EN	Chip Enable Pin, Active-high
4	FLG	Flag Pin, Open Drain Output
5	VOUT	Output Pin

R5524K Pin Description

Pin No.	Symbol	Description
1	VOUT	Output Pin
2	NC	No Connection
3	FLG	Flag Pin, Open Drain Output
4	EN	Enable Pin, Active-high
5	GND	Ground Pin
6	VIN	Input Pin

The exposed tab is substrate level (GND). It is recommended that the exposed tab be connected to the ground plane on the board or otherwise be left open.

ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings

Symbol	Item		Rating	Unit
V_{IN}	Input Voltage		6.0	V
V_{EN}	Enable Pin Input Voltage		-0.3 to 6.0	V
V_{FLG}	Flag Pin Voltage		-0.3 to 6.0	V
I_{FLG}	Flag Pin Current		14	mA
V_{OUT}	Output Pin Voltage		-0.3 to 6.0	V
I_{OUT}	Output Current		Internally Controlled	
P_D	Power Dissipation ⁽¹⁾	SOT-23-5, JEDEC STD.51-7	660	mW
		DFN(PLP)1820-6, JEDEC STD.51-7	2200	mW
T_j	Junction Temperature Range		-40 to 125	°C
T_{stg}	Storage Temperature Range		-55 to 125	°C

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Rating	Unit
V_{IN}	Operating Input Voltage	2.7 to 5.5	V
T_a	Operating Temperature Range	-40 to 85	°C

RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

⁽²⁾ Refer to *POWER DISSIPATION* for detailed information.

R5524x

NO.EA-188-190627

ELECTRICAL CHARACTERISTICS

The specifications surrounded by are guaranteed by design engineering at $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$.

R5524xxxxA/B Electrical Characteristics

($T_a = 25^{\circ}\text{C}$)

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
V_{IN}	Input Voltage		2.7		5.5	V
I_{DD1}	Supply Current (Active Mode)	$V_{\text{OUT}} = \text{OPEN}$, $\text{EN} = \text{"H"}$, $V_{\text{IN}} = 5\text{ V}$		110	180	μA
I_{DD2}	Supply Current (Standby Mode)	$V_{\text{OUT}} = \text{OPEN}$, $\text{EN} = \text{"L"}$, $V_{\text{IN}} = 5\text{ V}$		0.1	1.0	μA
R_{ON}	Switch On Resistance	$V_{\text{IN}} = 5\text{ V}$, $I_{\text{OUT}} = 500\text{ mA}$		100	150	$\text{m}\Omega$
t_{on}	Output Turn-on Delay	$V_{\text{IN}} = 5\text{ V}$, $R_{\text{L}} = 60\ \Omega$		400		μs
t_{off}	Output Turn-off Delay	$V_{\text{IN}} = 5\text{ V}$, $R_{\text{L}} = 60\ \Omega$		50		μs
V_{UVLO}	UVLO Release Voltage	V_{IN} Rising	2.3	2.5	2.7	V
V_{HYS}	UVLO Hysteresis Range	V_{IN} Falling		0.1		V
I_{TH}	Current Limit Threshold	R5524x001A/B R5524x002A/B $V_{\text{IN}} = 5\text{ V}$	650	800	980	mA
		R5524N004A $V_{\text{IN}} = 5\text{ V}$	1.25	1.55	1.85	A
		R5524N004A $V_{\text{IN}} = 5\text{ V}$, $0^{\circ}\text{C} \leq T_a \leq 70^{\circ}\text{C}$	1.2	1.55	1.9	
I_{LIM}	Overcurrent Limit	$V_{\text{IN}} = 5\text{ V}$, After 5 ms from when $V_{\text{OUT}} = 0\text{ V}^{(1)}$	550	650	800	mA
t_{FD}	Flag Delay Time ⁽²⁾	$V_{\text{IN}} = 5\text{ V}$, From when overcurrent detection until when $\text{FLG} = \text{"L"}$	7	20	30	ms
T_{TSD}	Thermal Shutdown Temperature	Junction Temperature		135		$^{\circ}\text{C}$
T_{TSR}	Thermal Shutdown Released Temperature	Junction Temperature		120		$^{\circ}\text{C}$
I_{EN}	Enable Pin Input Current			0.01	1.0	μA
V_{EN1}	Enable Pin Input Voltage 1	V_{EN} Rising	2.0		6.0	V
V_{EN2}	Enable Pin Input Voltage 2	V_{EN} Falling	-0.3		0.8	V
I_{LO}	Output Leakage Current			0.1	1.0	μA
V_{LF}	Flag "L" Output Voltage	$I_{\text{SINK}} = 1\text{ mA}$			0.4	V
I_{FOF}	Flag Off Current	$V_{\text{FLG}} = 5.5\text{ V}$		0.01	1.0	μA
I_{REV}	Reverse Leakage Current	$V_{\text{IN}} = 0\text{ V}$, $V_{\text{OUT}} = 5.5\text{ V}$			50	μA
R_{LOW}	Nch. On-resistance for Auto Discharge (R5524x00xA only)			450		Ω

All test items listed under Electrical Characteristics are done under the pulse load condition ($T_j \approx T_a = 25^{\circ}\text{C}$) except Thermal Shutdown Temperature and Thermal Shutdown Released Temperature.

⁽¹⁾ Refer to "Overcurrent limit Function" in THEORY OF OPERATION for details.

⁽²⁾ Flag Delay Time is dependent on Input Voltage.

THEORY OF OPERATION

Overcurrent Limit Function

The R5524x001A/001B has the built-in latch-off type over-current limit circuit. When the over-current is detected, the protection circuit becomes active and the switch-transistor is turned OFF. The latch function is released if the input voltage value is exceeded in the release threshold of the UVLO circuit value after when it became lower than the detection threshold of the UVLO circuit value; or the EN pin set to the enabling condition again after set to the disabling condition.

If the over current condition occurred when the input voltage value was close to the minimum operating input voltage value. Under this condition, the voltage descends by the parasitic impedance on the power supply side, and it might fall below the detection threshold of the UVLO circuit. In this case, the switch-transistor is turned OFF and because of that the voltage drop of power line's parasitic impedance stops; the latch function is released with the UVLO and it becomes the over current condition again. The switch transistor keeps continual ON and OFF until one of the following is done; increasing the input voltage value; the setting of EN pin is disabling; or reducing the value of load current.

Moreover, the supply-voltage changed by the load-current dramatically changed depends upon the parasitic impedance of the wiring on the load side or the power supply side. Due to this, decreasing the parasitic impedance by the wiring on board is recommended.

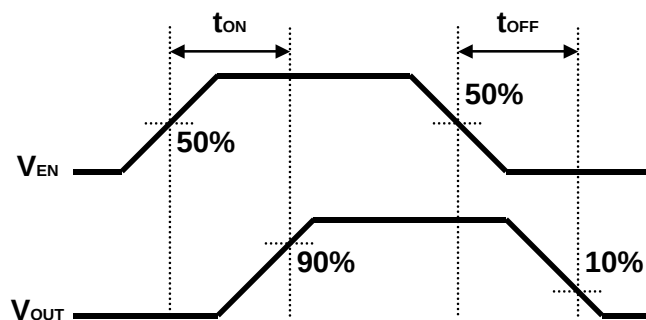
The switch transistor of the R5524x001A/001B is turned OFF when the latch-off-function operates under the condition of the load of the constant current as the load device, such as the electronic load and so on, connecting with the V_{OUT} pin of the R5524x001A/001B. Because the load device keeps the constant current, the V_{OUT} pin voltage may become negative potential. If the V_{OUT} pin is exceed the absolute maximum rating may cause the permanent damages to the device, please avoid using in this situation.

The R5524x002A/002B and R5524N004A have the built-in over current protection circuit as the constant current type. It detects as the over-current condition, if the current flows as the I_{TH} defined. Then operating the switch transistor to limit the output current to be the constant current defined by the I_{LIM} .

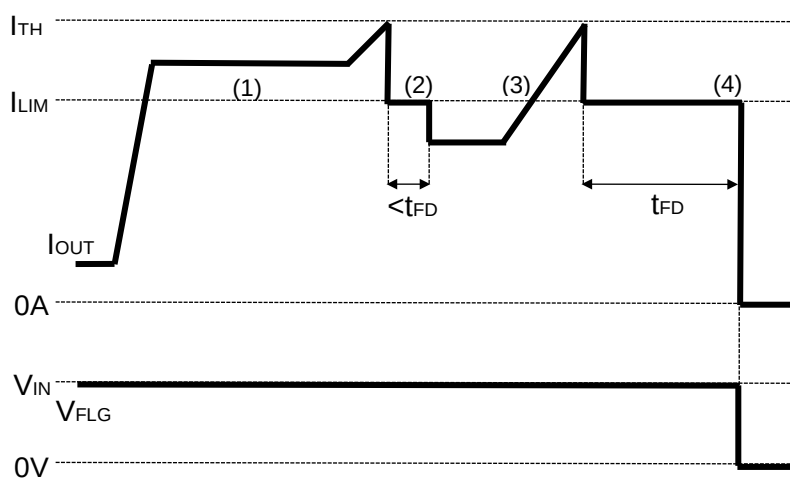
If the condition of the over-current limit caused by the V_{OUT} pin clamped to the GND were continued the temperature of the ICs would increase drastically. The switch-transistor is turned OFF if the temperature of the ICs becomes over 135°C (Typ.). And after this, the switch-transistor is turned ON again when the temperature of ICs decreased approximately 15°C. The switch-transistor keeps continual ON and OFF until either the switch is turned OFF or the V_{OUT} pin is removed from GND.

Timing Chart**R5524xxxxA/B**

Output On-time and Output Off-time

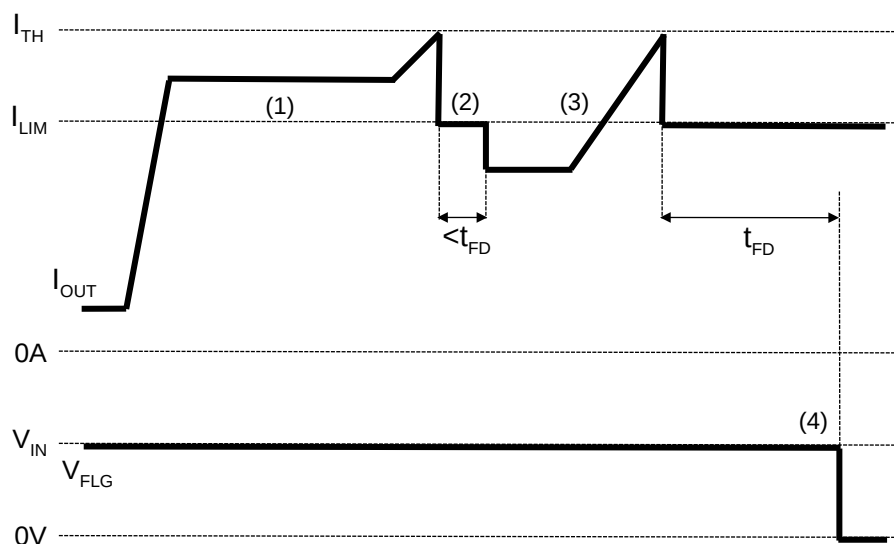
**R5524x Timing Chart****R5524x001A/B (Latch-off Type)**

Flag Delay Time

**R5524x001A/001B (Latch-off Type) Timing Chart**

- (1) When the I_{OUT} is I_{TH} or less, the current is not limited.
- (2) Once the I_{OUT} reaches to I_{TH} , the I_{OUT} is limited by I_{LIM} .
- (3) When the I_{OUT} drops to I_{LIM} or less within the t_{FD} time, the current limit is released. The current is not limited until the I_{OUT} exceeds I_{TH} again.
- (4) When the I_{OUT} reaches to I_{TH} and it is limited by I_{LIM} for t_{FD} or more, the switch transistor turns off and V_{FLG} becomes "Low".

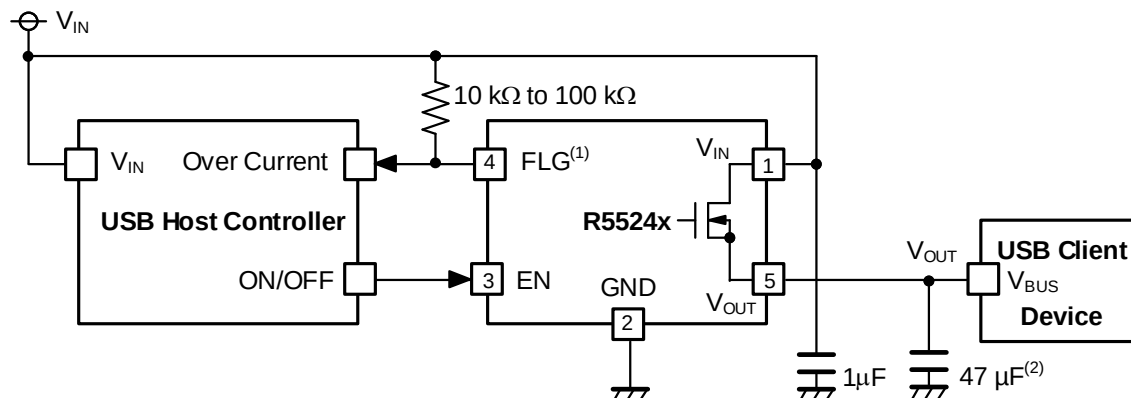
Flag Delay Time



R5524x002A/002B and R5524N004A (Constant Current Type) Timing Chart

- (1) When I_{OUT} is I_{TH} or less, the current is not limited.
- (2) Once the I_{OUT} reaches to I_{TH} , the I_{OUT} is limited by I_{LIM} .
- (3) When the I_{OUT} drops to I_{LIM} or less within the t_{FD} time, the current limit is released. The current is not limited until the I_{OUT} exceeds I_{TH} again.
- (4) When the I_{OUT} reaches to I_{TH} and it is limited by I_{LIM} for t_{FD} or more, the V_{FLG} becomes "Low".

APPLICATION INFORMATION



R5524x Typical Reference Circuit

Precautions for Selecting External Components

Bypass Capacitor

A $0.1\mu\text{F}$ to $1\mu\text{F}$ bypass capacitor between the V_{IN} pin and the GND pin, close to the device, is recommended. This precaution reduces power supply transients that may cause ringing on the input.

Pull-up Resistor of FLG Pin

A $10\text{ k}\Omega$ to $100\text{ k}\Omega$ pull-up resistor is recommended for the FLG pin.

R5524x001A/001B

The R5524x001A/001B is equipped with a latch-off function which requires initialization before start-up.

Case 1: Start-up by EN Pin Control

EN pin must be enabled with the delay of $10\mu\text{s}$ or more against 90% of V_{IN} voltage rising edge.

Case 2: Start-up by EN Pin Tied to V_{IN} Pin

Slew rate of V_{IN} must be $40\mu\text{s/V}$ or slower.

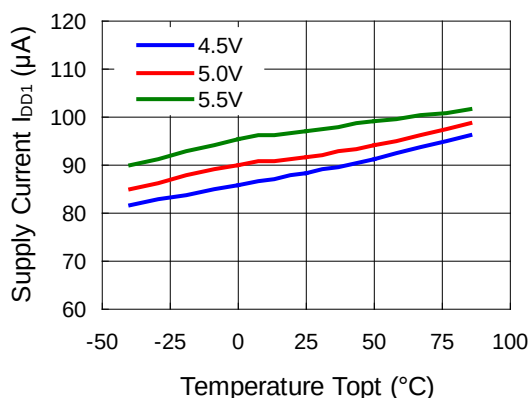
⁽¹⁾ FLG pin is Nch. Open Drain Output.

⁽²⁾ A $47\mu\text{F}$ or more output capacitor is recommended. According to a USB standard, a $120\mu\text{F}$ or more output capacitor is required.

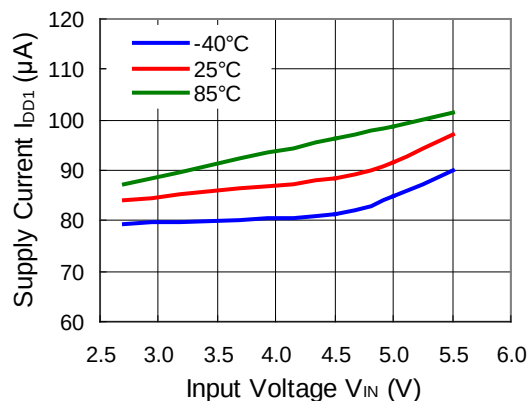
TYPICAL CHARACTERISTICS

Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.

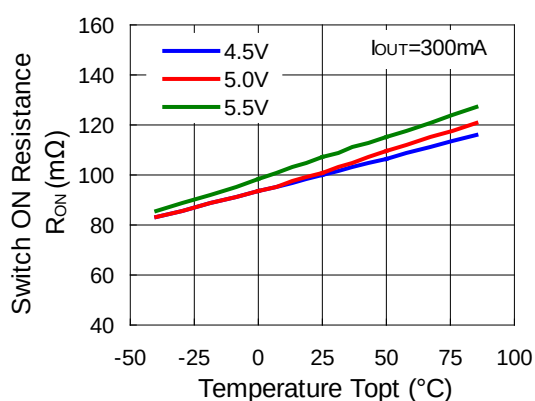
1) Supply Current vs. Temperature



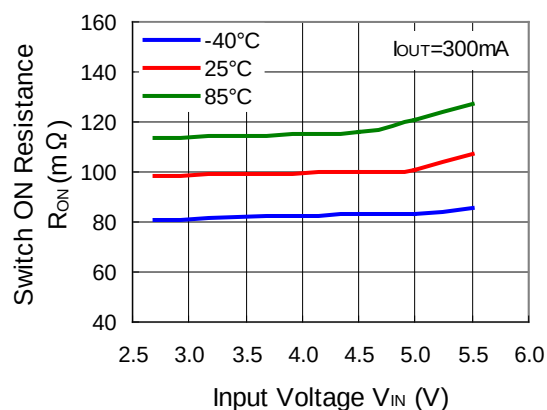
2) Supply Current vs. Input Voltage



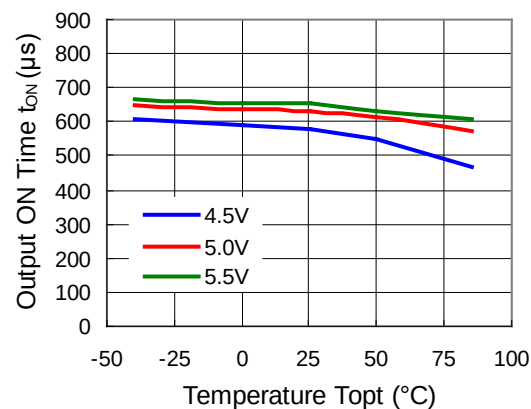
3) Switch ON Resistance vs. Temperature



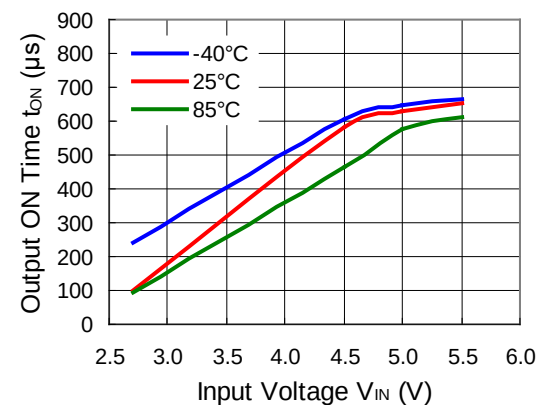
4) Switch ON Resistance vs. Input Voltage

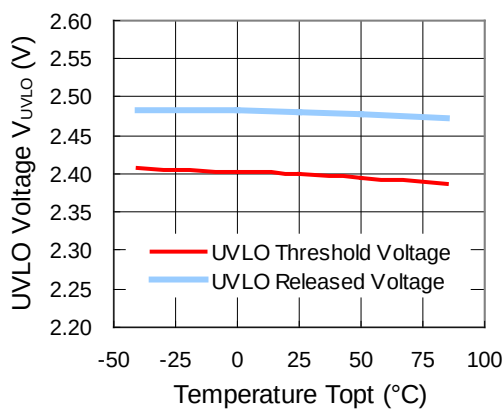
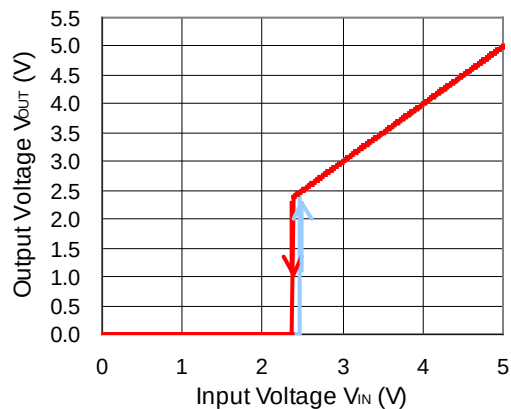
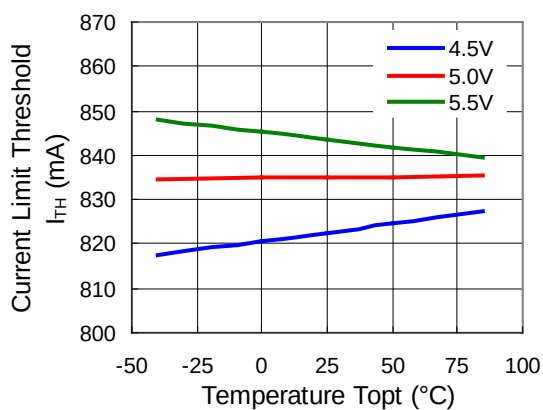
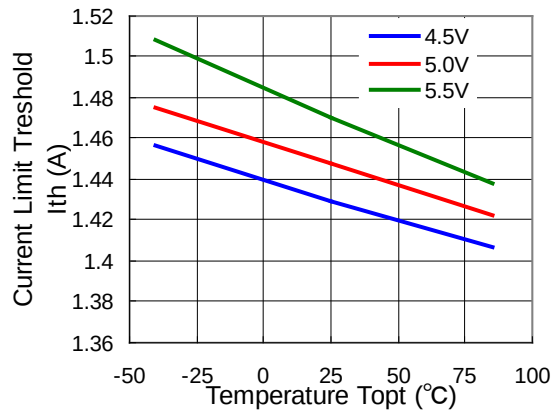
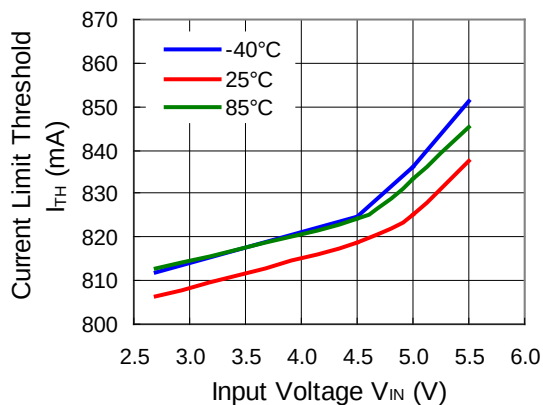
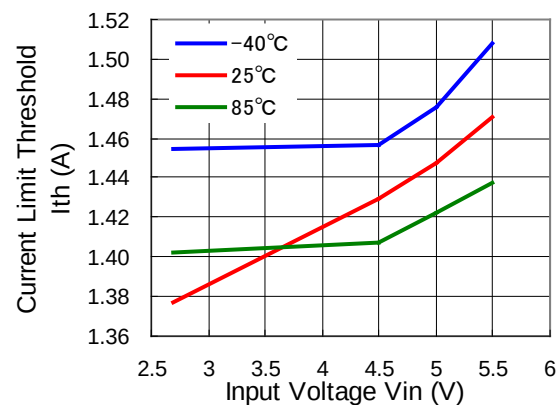


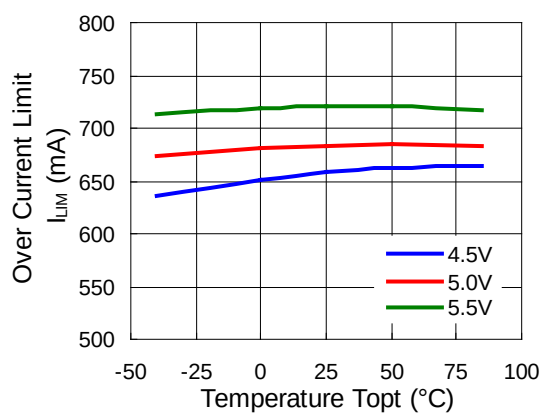
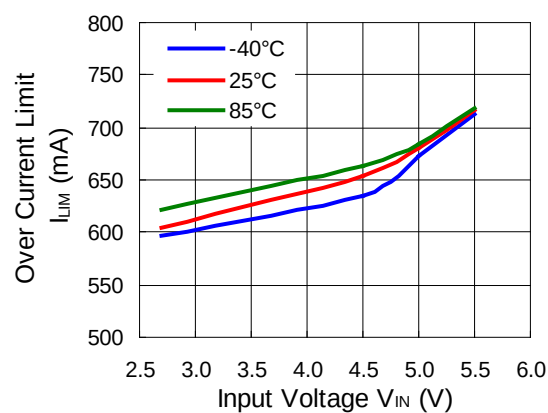
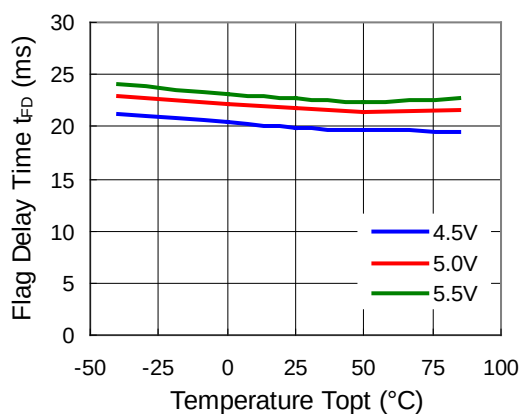
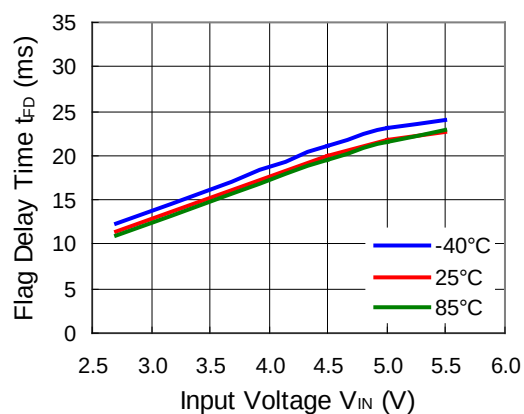
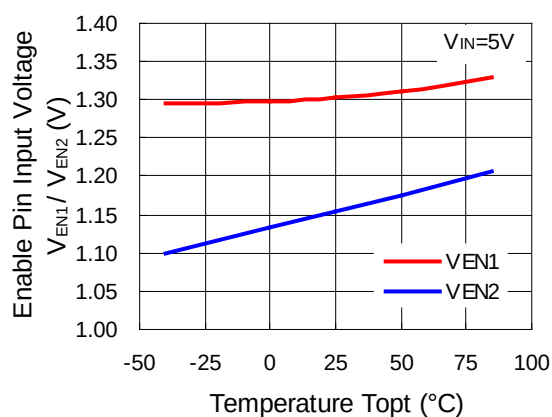
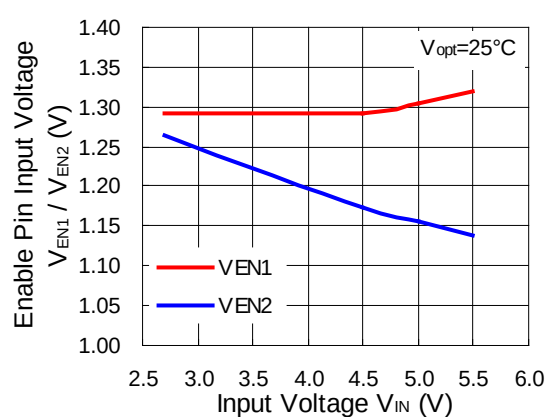
5) Output ON Time vs. Temperature ($R_L = 56 \Omega$)



6) Output ON Time vs. Input Voltage ($R_L = 56 \Omega$)

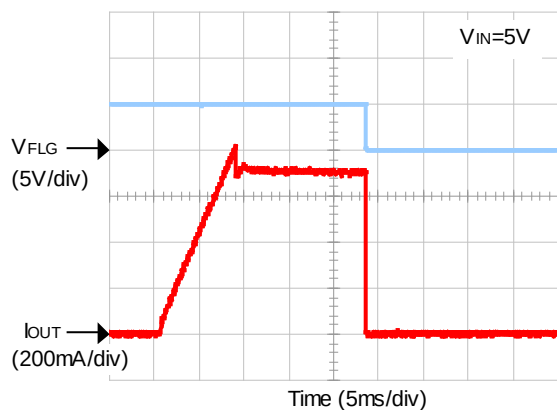


7) UVLO Voltage vs. Temperature

8) Output Voltage vs. Input Voltage

9) Current Limit Threshold vs. Temperature (001x/ 002x)

10) Current Limit Threshold vs. Temperature (004A)

11) Current Limit Threshold vs. Input Voltage (001x/ 002x)

12) Current Limit Threshold vs. Input Voltage (004A)


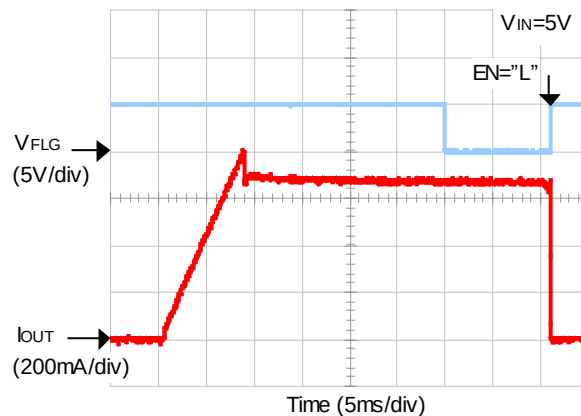
13) Overcurrent Limit vs. Temperature**14) Overcurrent Limit vs. Input Voltage****15) Flag Delay Time vs. Temperature****16) Flag Delay Time vs. Input Voltage****17) Enable Input Voltage vs. Temperature****18) Enable Input Voltage vs. Input Voltage**

19) Overcurrent Response with Ramped Load 20) Overcurrent Response with Ramped Load

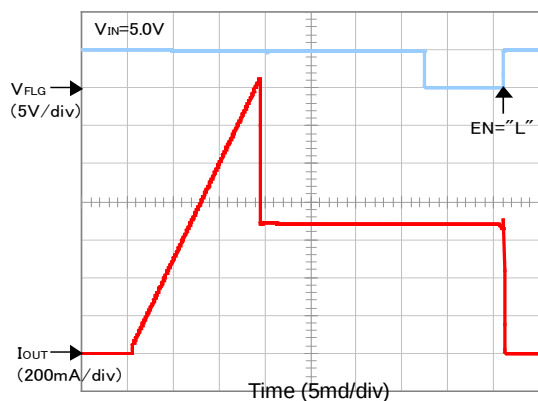
(R5524x001x)



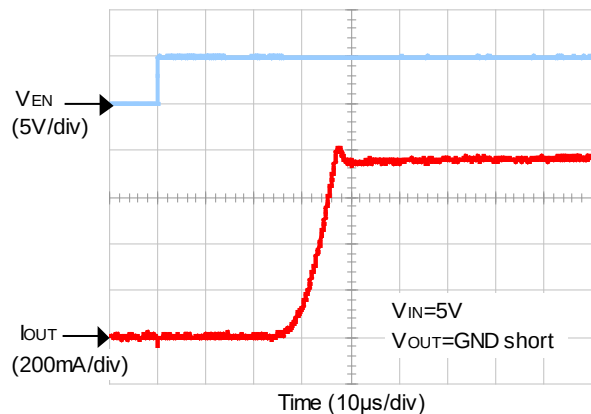
(R5524x002x)



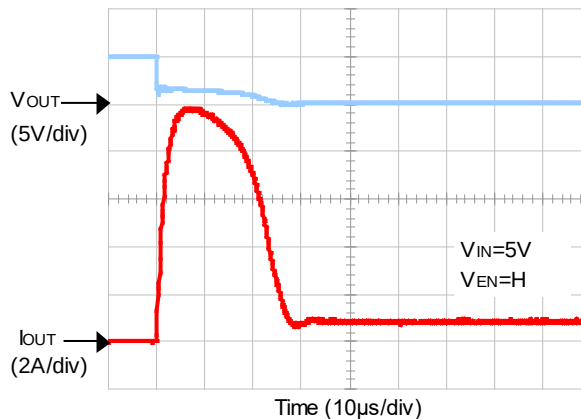
21) Overcurrent Response with Ramped Load
(R5524x004A)



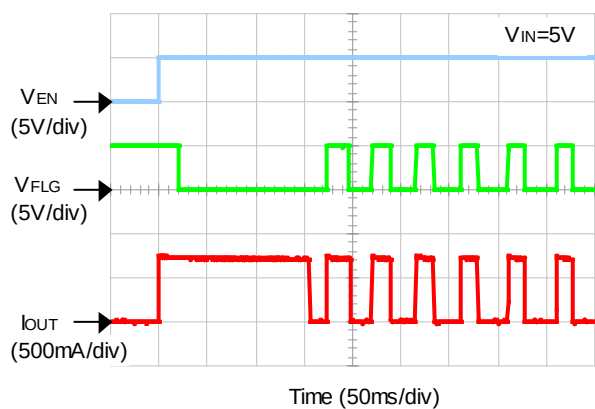
22) Overcurrent Limit Transient Response
(Output short during enable "H")



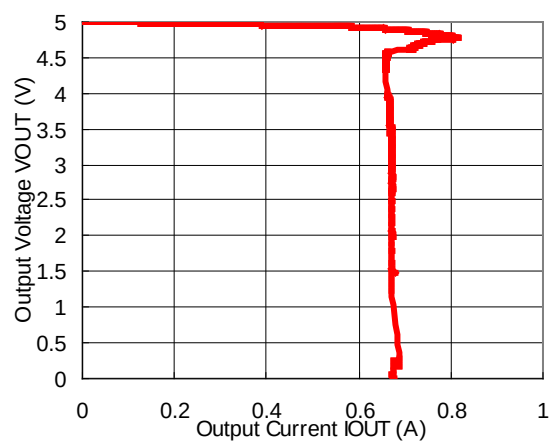
(Enable "H" during Output Short)



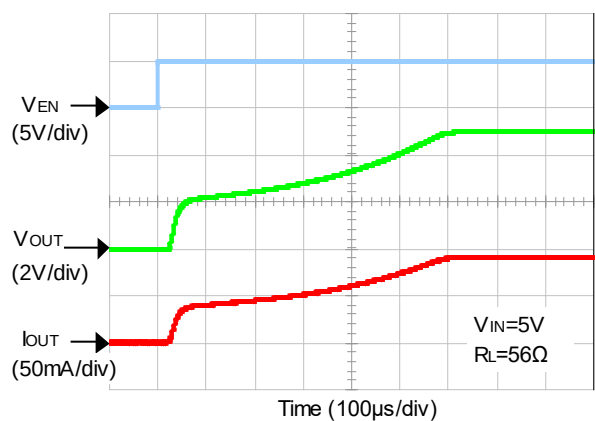
23) Thermal Shutdown Operation



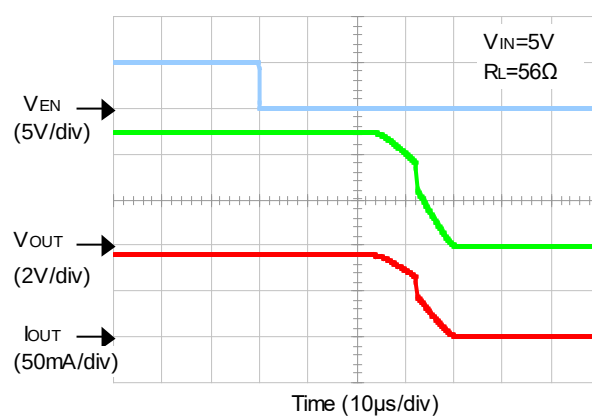
24) Output Voltage vs. Output Current



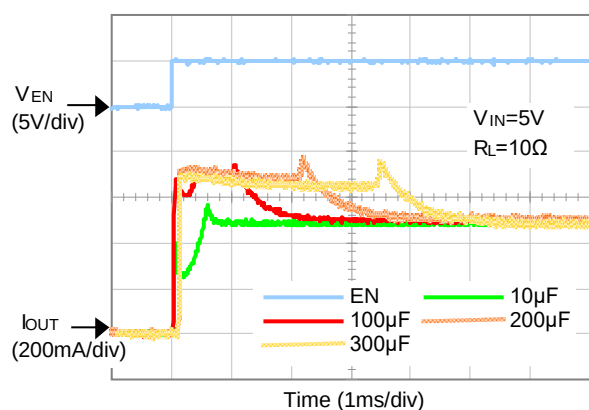
25) Output ON Time Response



26) Output OFF Time Response



27) Inrush current Characteristic



The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 7 pcs

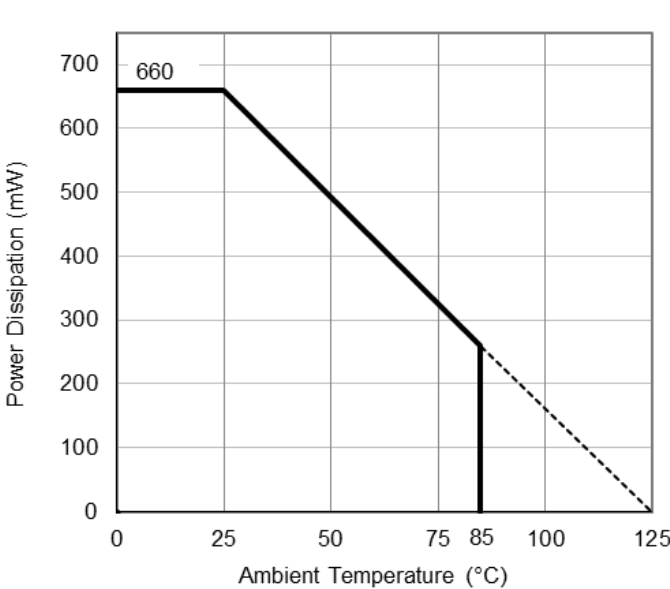
Measurement Result

(Ta = 25°C, Tjmax = 125°C)

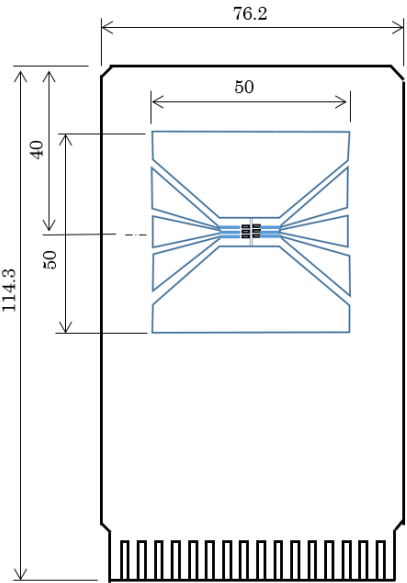
Item	Measurement Result
Power Dissipation	660 mW
Thermal Resistance (θja)	θja = 150°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 51°C/W

θja: Junction-to-Ambient Thermal Resistance

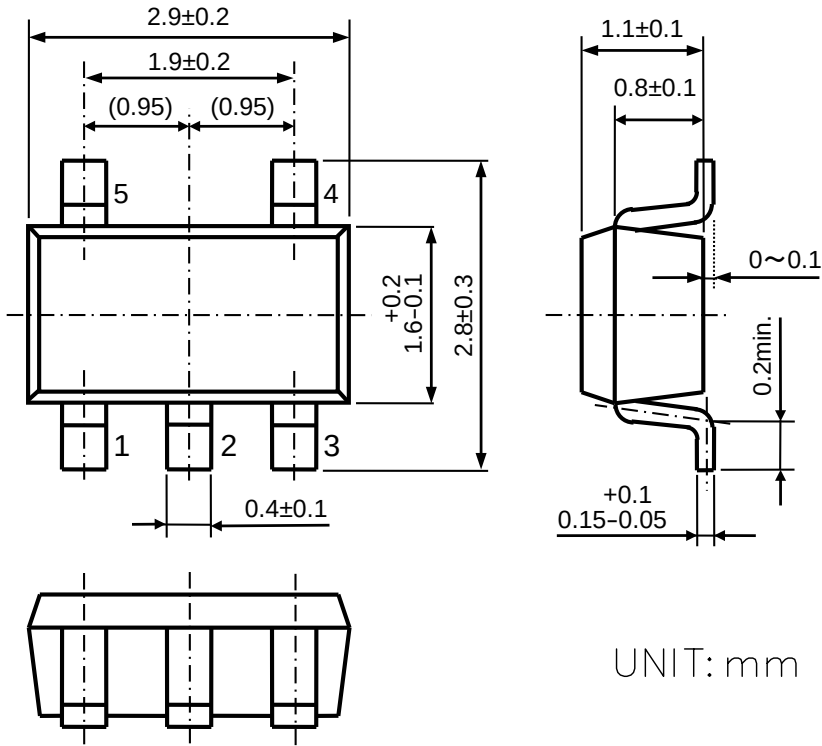
ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern



SOT-23-5 Package Dimensions

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

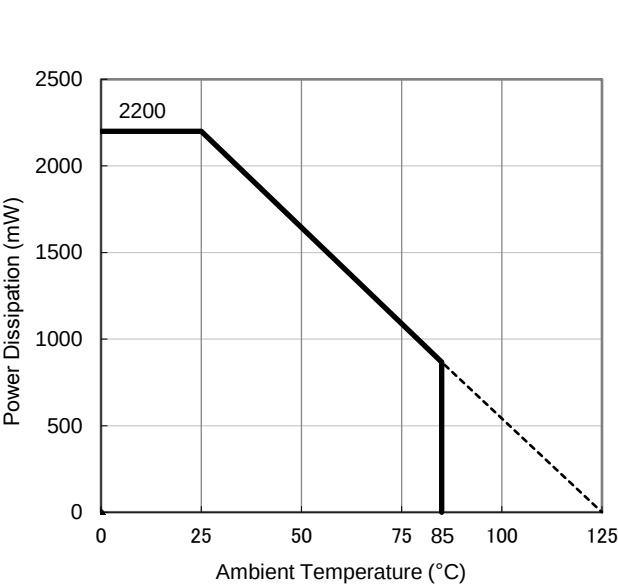
Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.2 mm × 34 pcs

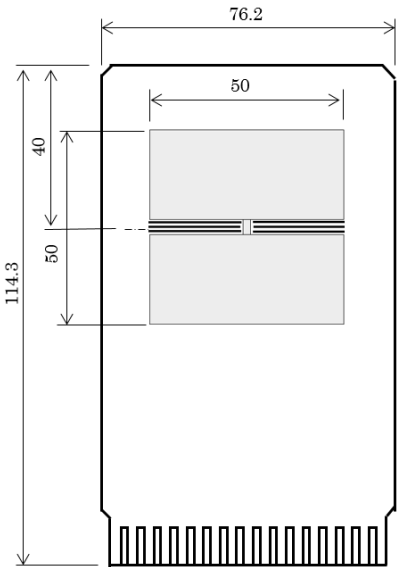
Measurement Result (Ta = 25°C, Tjmax = 125°C)

Item	Measurement Result
Power Dissipation	2200 mW
Thermal Resistance (θja)	θja = 45°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 18°C/W

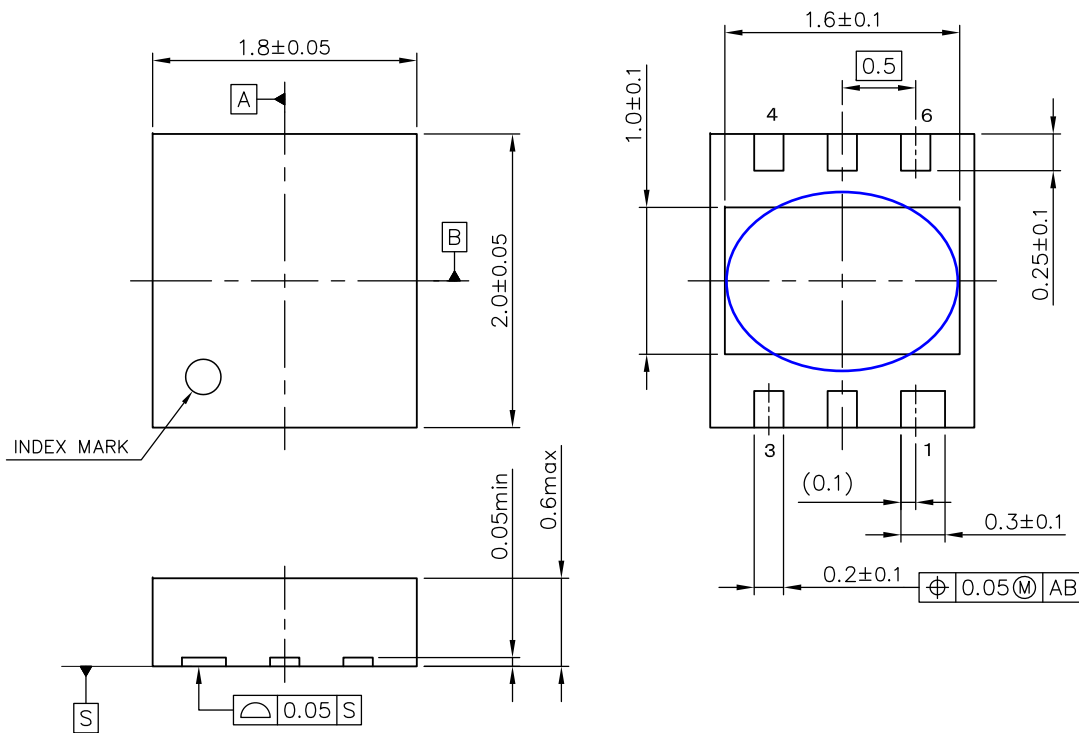
θja: Junction-to-Ambient Thermal Resistance
ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern



DFN(PLP)1820-6 Package Dimensions

* The tab on the bottom of the package is substrate level (GND). It is recommended that the tab be connected to the ground plane on the board, or otherwise be left floating.



1. The products and the product specifications described in this document are subject to change or discontinuation of production without notice for reasons such as improvement. Therefore, before deciding to use the products, please refer to Ricoh sales representatives for the latest information thereon.
2. The materials in this document may not be copied or otherwise reproduced in whole or in part without prior written consent of Ricoh.
3. Please be sure to take any necessary formalities under relevant laws or regulations before exporting or otherwise taking out of your country the products or the technical information described herein.
4. The technical information described in this document shows typical characteristics of and example application circuits for the products. The release of such information is not to be construed as a warranty of or a grant of license under Ricoh's or any third party's intellectual property rights or any other rights.
5. The products listed in this document are intended and designed for use as general electronic components in standard applications (office equipment, telecommunication equipment, measuring instruments, consumer electronic products, amusement equipment etc.). Those customers intending to use a product in an application requiring extreme quality and reliability, for example, in a highly specific application where the failure or misoperation of the product could result in human injury or death (aircraft, spacevehicle, nuclear reactor control system, traffic control system, automotive and transportation equipment, combustion equipment, safety devices, life support system etc.) should first contact us.
6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
7. Anti-radiation design is not implemented in the products described in this document.
8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact Ricoh sales or our distributor before attempting to use AOI.
11. Please contact Ricoh sales representatives should you have any questions or comments concerning the products or the technical information.



Ricoh is committed to reducing the environmental loading materials in electrical devices with a view to contributing to the protection of human health and the environment.

Ricoh has been providing RoHS compliant products since April 1, 2006 and Halogen-free products since April 1, 2012.

RICOH RICOH ELECTRONIC DEVICES CO., LTD.

<https://www.e-devices.ricoh.co.jp/en/>

Sales & Support Offices

Ricoh Electronic Devices Co., Ltd.

Shin-Yokohama Office (International Sales)

2-3, Shin-Yokohama 3-chome, Kohoku-ku, Yokohama-shi, Kanagawa, 222-8530, Japan
Phone: +81-50-3814-7687 Fax: +81-45-474-0074

Ricoh Americas Holdings, Inc.

675 Campbell Technology Parkway, Suite 200 Campbell, CA 95008, U.S.A.
Phone: +1-408-610-3105

Ricoh Europe (Netherlands) B.V.

Semiconductor Support Centre

Prof. W.H. Keesomlaan 1, 1183 DJ Amstelveen, The Netherlands
Phone: +31-20-5474-309

Ricoh International B.V. - German Branch

Semiconductor Sales and Support Centre

Oberrather Strasse 6, 40472 Düsseldorf, Germany
Phone: +49-211-6546-0

Ricoh Electronic Devices Korea Co., Ltd.

3F, Haesung Bldg, 504, Teheran-ro, Gangnam-gu, Seoul, 135-725, Korea
Phone: +82-2-2135-5700 Fax: +82-2-2051-5713

Ricoh Electronic Devices Shanghai Co., Ltd.

Room 403, No.2 Building, No.690 Bibo Road, Pu Dong New District, Shanghai 201203,
People's Republic of China
Phone: +86-21-5027-3200 Fax: +86-21-5027-3299

Ricoh Electronic Devices Shanghai Co., Ltd.

Shenzhen Branch

1205, Block D(Jinlong Building), Kingkey 100, Hongbao Road, Luohu District,
Shenzhen, China
Phone: +86-755-8348-7600 Ext 225

Ricoh Electronic Devices Co., Ltd.

Taipei office

Room 109, 10F-1, No.51, Hengyang Rd., Taipei City, Taiwan
Phone: +886-2-2313-1621/1622 Fax: +886-2-2313-1623

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Ricoch Electronics:](#)

[R5524N004A-TR-FE](#) [R5524N002A-TR-FE](#) [R5524N001B-TR-FE](#) [R5524N001A-TR-FE](#) [R5524N002B-TR-FE](#)
[R5524N002B-TL-FE](#)



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.